

200mA Surface Mount Small Signal Diodes

■ Features

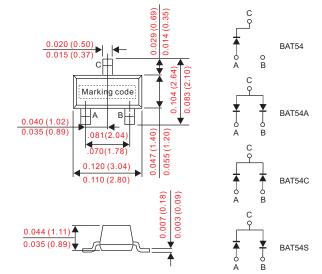
- · Low current rectification and high speed switching.
- · Small surface mount type.
- Up to 200mA current capability.
- Low forward voltage drop (VF = 1.00V typ. @100mA).
- Silicon epitaxial planar chip, metal silicon junction.
- High speed (trr < 5 ns)
- Suffix "G" indicates Halogen-free part, ex.BAT54G.
- Lead-free parts for green partner, exceeds environmental standards of MIL-STD-19500 /228

■ Mechanical data

- Epoxy:UL94-V0 rated flame retardant
- Case: Molded plastic, SOT-23
- Terminals : Solder plated, solderable per MIL-STD-750, Method 2026
- Mounting Position : Any
- Weight: Approximated 0.008 gram

Outline

SOT-23



Dimensions in inches and (millimeters)

■ Maximum ratings and electrical characteristics

Rating at 25° C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic		Symbol	BAT54	BAT54A	BAT54C	BAT54S	UNIT	
Marking code			JV3	В6	KL3	LD3] UNIT	
Reverse Voltage		V _R	30			V		
Forward Power Dissipation(1)	TA = 25°C	P _e	200				mW	
	Derate above 25°C		2.0				mW/°C	
Forward Current(DC)		I _F	200			mA		
Junction Temperature		T _J	+125		°C			
Storage Temperature		T _{stg}	-55 ~ +150			°C		

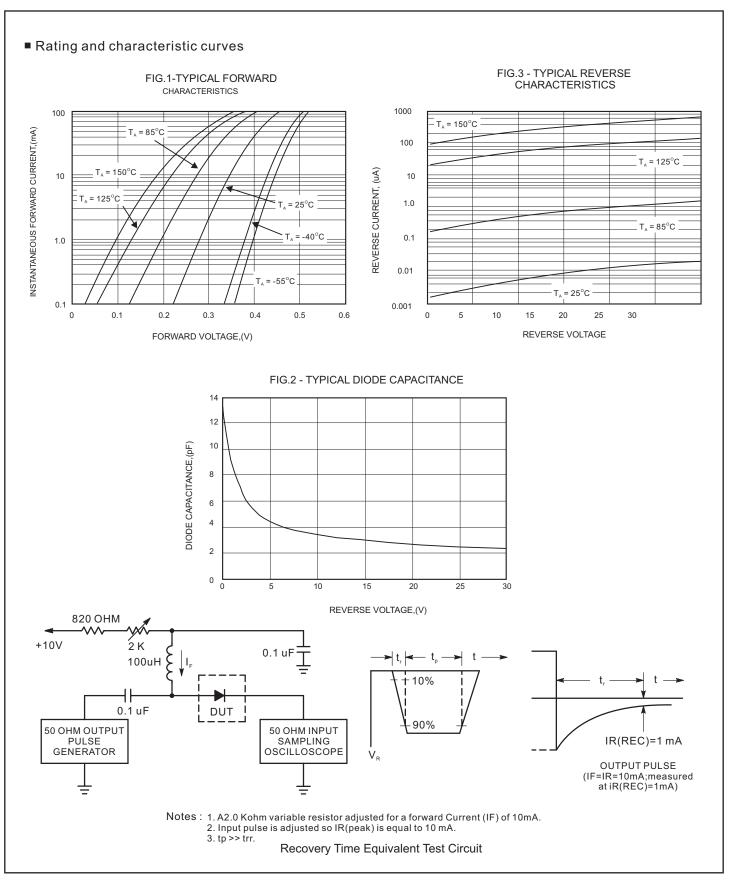
Characteristic		Symbol	MIN.	TYP.	MAX.	UNIT
Reverse Breakdown Voltage	I(_{BR}) = 10uAdc	V _(BR)	30			Vdc
Reverse Voltage Leakage Current	V _R = 25Vdc I _R 0.5 2.0		uAdc			
Total Capacitance	V _R = 1.0, f = 1.0MHz	C _T		7.6	10	pF
Forward Voltage	$I_F = 0.1 \text{mAdc}$			220	240	
	$I_F = 1.0 \text{mAdc}$			290	320	
	$I_F = 10 \text{mAdc}$	$V_{\scriptscriptstyle F}$		350	400	mVdc
	$I_F = 30 \text{mAdc}$			410	500	
	$I_F = 100 \text{mAdc}$			520	1000	
Reverse Recovery Time $I_F = I_R = 10 \text{mAdc}$,	$V_R = 5.0 \text{Vdc}, I_{R(REC)} = 1.0 \text{mAdc}, R_L = 100 \Omega$	trr			5.0	nS
Forward Current(DC)		I _F			200	mAdc
Repetitive Peak Forward Current		I _{FRM}			300	mAdc
Non-Repetitive Peak Forward Current	t < 1.0s	I _{FSM}			600	mAdc

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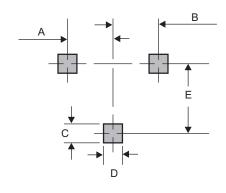
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■ SOT-23 foot print



Α	В	С	D	E
0.037 (0.95)	0.037 (0.95)	0.035 (0.90)	0.031 (0.80)	0.079 (2.00)

Dimensions in inches and (millimeters)

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